



# **SPECIFICATION**



# PH800480T-013-IHB

7" - WVGA - RGB/TTL

Version: 1.8

Date: 03.08.2017

Note: This specification is subject to change without prior notice

### **SPECIFICATIONS**

CUSTOMER · CDE012

SAMPLE CODE . SH800480T013-IHB

MASS PRODUCTION CODE . PH800480T013-IHB

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 008

DRAWING NO. (Ver.) . LMD-PH800480T013-IHB (Ver.004)

PACKAGING NO. (Ver.) . PKG-PH800480T013-IHB (Ver.001)

# **Customer Approved**

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☐ Preliminary specification for design input

Specification for sample approval

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# **History of Version**

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
07/13/2016	01	001	New Drawing	-	徐明菲
09/08/2016	01	002	Modify Specs.(Drawing)	-	徐明菲
09/08/2016	01	003	New Sample.	-	Ackey
11/29/2016	01	004	Update RTP Interface Name.	-	Ackey
01/24/2017	01	005	Update Absolute Maximum Ratings.	-	Ackey
02/14/2017	01	006	Update Operational Power Supply For Backlight.	5	Ackey
03/13/2017	01	007	Modify Drawing.	Appendix	Ackey
08/03/2017	01	008	Update DC Electrical Characteristics.	5	Ackey

Total: 30 Page



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# 1. SPECIFICATIONS

### 1.1 Features

Item	Standard Value
Display Resolution	800 *3 (RGB) * 480 Dots
LCD Type	a-Si TFT , Normally white , Transmissive type
Screen size(inch)	7.0 inch
Viewing Direction	6 O'clock
Surface treatment	Anti-Glare
Color configuration	R.G.B. Vertical Stripe
Weight	
Interface	24 Bits RGB Interface
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer website:
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1

# 1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	164.9 (W) * 100.0 (L) * 4.95 (H)	mm

# LCD panel

Item	Standard Value	Unit
Active Area	154.08 (W) * 85.92 (L)	mm

Note: For detailed information please refer to LCM drawing.



## 1.3 Absolute Maximum Ratings

#### **Module**

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Supply Voltage	VDD	GND=0	-0.3	+5.0	V	
Power Supply Voltage	VCC	GND=0	-0.3	+20.0	V	
Operating	Top	_	-20	+70	∞	-
Temperature	TOP	_	-20	+70	Ò	
Storage Temperature	T <sub>ST</sub>	-	-30	+80	∞	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

### 1.4 DC Electrical Characteristics

**Module** GND = 0V,  $Ta = 25 ^{\circ}C$ 

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply for TFT Panel	VDD	GND=0V	3.0	3.3	3.6	٧
Power Supply for Backlight Unit	VCC	GND=0V	5	12	15	٧
Input Voltage for TFT	VIH	GND=0V	0.7VDD	-	VDD	٧
Panel	VIL	GND=0V	0	-	0.3VDD	V
Supply Current for TFT Panel	IDD	IDD@VDD=3.3V	-	110	165	mA
Supply Current for Backlight Unit	ICC	ICC@VCC=5V	-	850	1275	mA
Supply Current for Backlight Unit	ICC	ICC@VCC=12V	-	240	360	mA
Input Voltage for	VPH	GND=0V	1.2	-	-	V
PWM Signal	VPL	GND=0V	-	-	0.4	V
Dimming Clock Rate	fP	GND=0V	5	-	100	KHz



# 1.5 Optical Characteristics

#### **TFT LCD Module**

VDD = 3.3 V, Ta=25 ℃

	1			1	1	1		
Item		Symbol	Condition	Min.	Тур.	Max.	unit	
Posponso timo	Rise	Tr		-	10	20	mo	Note 2
Response time	Fall	Tf	-	-	15	30	ms	Note 2
	Тор	θΥ+		40	50			
Viewing angle	Bottom	θΥ-	CR ≥ 10	60	70	-	Deg.	Note 4
viewing angle	Left	θХ-	ON 2 10	60	70	-	Deg.	Note 4
	Right	θΧ+		60	70	-		
Contrast ratio	)	CR	-	400	500	-	-	Note 3
	White	Х		0.25	0.30	0.35		
	vviiite	Υ		0.29	0.34	0.39		
	Red	X	\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	0.52	0.57	0.62		
Color of CIE Coordinate	1160	Υ	VCC=12.0V	0.30	0.35	0.40		Note1
( LCD & BL & TP )	C 112 2 12	Green X	PWM="High" (Duty=100%)	0.29	0.34	0.39	_	NOLET
	areen	Y	(Daty=10070)	0.55	0.60	0.65		
	Blue	X		0.10	0.15	0.20		
	Dide	Υ		0.03	0.08	0.13		
Average Brightn Pattern=white dis ( LCD & BL & TP	play	IV	VCC=12.0V PWM="High"	640	800	-	cd/m <sup>2</sup>	Note1
Uniformity ( LCD & BL & TF			(Duty=100%)	70	-	-	%	Note1



#### Note 1:

\*1: \( \triangle B = B(min) / B(max) \* 100%

\*2 : Measurement Condition for Optical Characteristics:

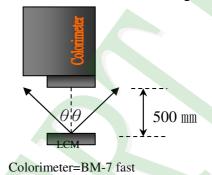
a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.

b : Measurement Distance: 500  $\pm$  50 mm  $\rightarrow$  ( $\theta$ = 0°)

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





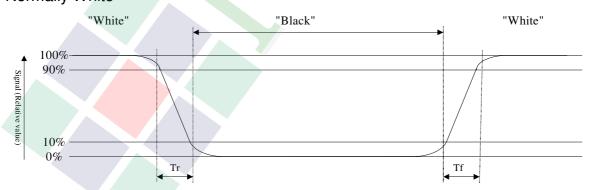
To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

### Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

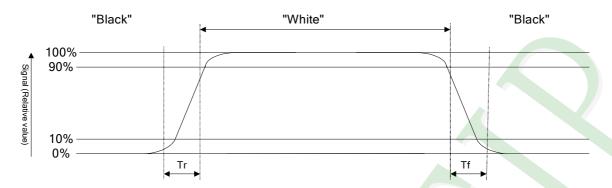
#### Refer to figure as below:

#### Normally White





### Normally Black



Note3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

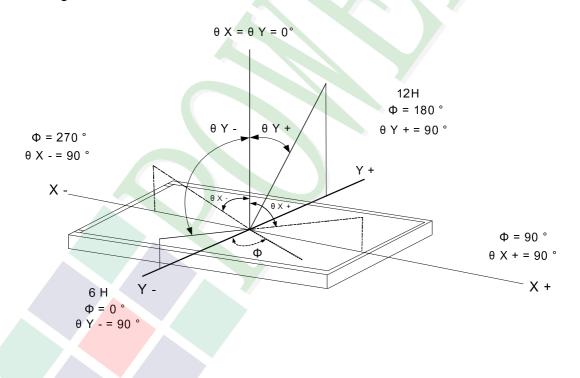
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

### Note4: Definition of viewing angle:

Refer to figure as below:





# 1.6 Backlight Characteristics

Maximum Ratings

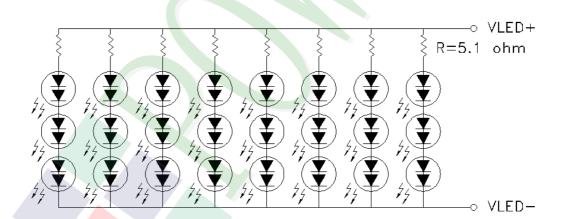
Item	Symbol	Min.	Max.	Unit	Remark
LED Forward Current	lF	35		mA	One LED
LED Reverse Voltage	VR	10		٧	One LED

**Electrical / Optical Characteristics** 

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
LED Voltage	VL	14.7	18.0	19.2	V	Note1
LED Current	ΙL	-	140	-	mA	<u>-</u>
LED life time	-	50000	-	-	Hr	Note2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25 °C and I∟=140 mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25 °C and I∟=140 mA. The LED life time could be decreased if operating I∟ is larger than 140 mA.





# 1.7 Touch Panel Characteristics

# 1.7.1 Optical Characteristics

Item	Specification
1.Transparency	80% Min

# 1.7.2 Mechanical Characteristic

Item	Specification
1.Input Method	Finger or stylus pen
2.Hardness of surface	3H -pressure 500g of ,45deg.
3.Activation Force	250gf less individual point with stylus pen(R0.8) Activation force guarantee area:3.0mm inside of Active Area.
4.Linearity Force	150gf less input with stylus pen(R0.8) Activation force guarantee area:3.0mm inside of Active Area.

# 1.7.3 Electrical Characteristics

Item	Specification		
1.Rated Voltage	DC 5V(DC 7V Max)		
2.Resistance Between	Direction X (Glass side): 500Ω~ 1000Ω		
Terminals.	Direction Y (Film side): 100Ω~ 500Ω		
3.Insulation Resistance	20 MΩ or more (DC 25 V 1min)		
4.Linearity	±1.5%.		
	Linearity(%)= $\Delta V/$ (EV-SV) *100.		
	$\Delta V\!\!:$ The difference between the ideal voltage and measured voltage on the each measuring line.		
	SV: Voltage of starting Points.		
	EV: Voltage of Ending Points.		
	(Test condition refers to 1.7.2 item4)		
5.Bouncing	<10ms (Tip R 3.75mm, hardness 10°~20°, silicon rubber ,500gf		
	operation : 40 mm/sec )		



# 1.7.4 Reliability Characteristic

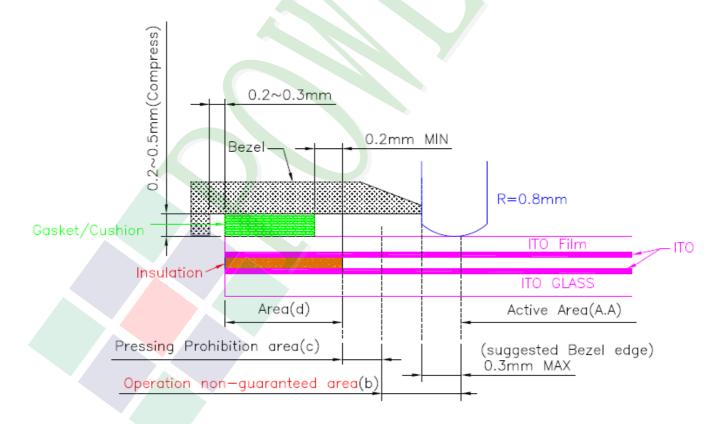
NO	Test Item	Test Condition	Test Result
	Hitting Durability	1,000,000times min.(R 8 mm	Follow 1.7.3 item2 and item4.
1		Silicon Rubber Hardness 60°	
		250gf 2times/sec).	
2	Pen Sliding Durability	100,000 times min(Tip R0.8mm).	Follow 1.7.3 item2 and item4.
		ψ9mm steel ball is dropped on the	No Crack
3	Impact Resistance	surface from 30 cm height at 1	
		time.	
4	Flexible pattern Bending	Bending 3 times by bending	Follow 1.7.3 item2.
4	Resistance	radius R1.0 mm	



### 1.7.5 Touch Panel Design/Handing Guide

- (1) Keep the gap, for example 0.2 to 0.3mm, between bezel edge and T/P edge.

  The reason is to avoid the bezel edge from contacting T/P surface that may cause "short" with bottom layer
- (2) Insertion a cushion material is recommended.
- (3) The cushion material should be limited on the busbar insulation paste area. If it is over the transparent insulation paste area, a "short" may be occurred.
- (4) Do not to use an adhesive tape to bond it on the front of T/P and hang it to the housing bezel.
- (5) Never expand the T/P top layer (PET Film) like a balloon by internal air pressure. The life of the T/P will extremely decreasing.
- (6) Top layer, PET, dimension is changing base on environment temperature and humidity. Please avoid a stress from housing bezel to top layer, because it may cause "waving".
- (7) The input to the Touch Panel sometimes distorts touch panel itself.
- (8)To use the stylus pen or fingernail sliding at the edge of the housing is prohibited. It would cause the cracking of the ITO coating and damage the touch panel. It also request not to press this area while assembling
- (9) Purpose: In order to prevent accidental use and performance deterioration, please keep the following precautions.



In order to prevent unusual performance degradation and malfunction of a touch panel, please carry out the set case designing and a touch panel assembling method after surely considering the definition of each area illustrated in above figure.



#### Area(a): Active area

The active area is guaranteed the position data detectable precision, operation force and other operations. it is strongly recommended to place the operation button or menu keys within the active area. Due to structure, the active area is less durable at the edge or close to the edge.

#### Area(b): Operation non-guaranteed area

This area does not guarantee a touch panel operation and its function. When this area is pressed, touch panel shows degradation of its performance and durability such as a pen sliding durability becomes about one-tenth compared with the active area (area-(a) as guaranteed area) and its operation force requires about double. About 0.5 mm outside from a boundary of the active area corresponds to this area.

#### Area(c): Pressing prohibition area

The area which forbids pressing, because an excessive load is applied to a transparent electrode (ITO) and a serious damage is given to a touch panel function by pressing. About 0.5 mm outside from Operation non-guaranteed area.

Area(d): Non-Active area

The area does not activate even if pressed.





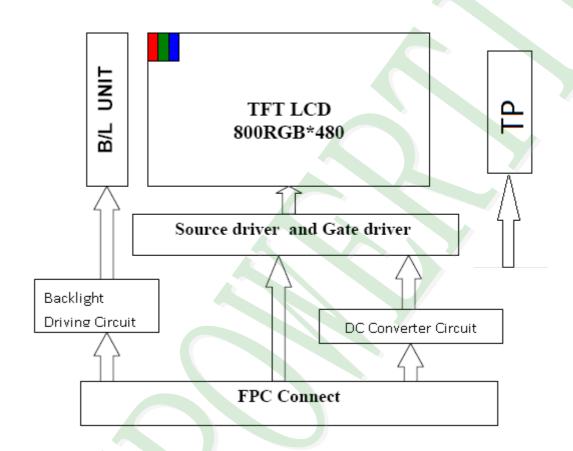
# 2. MODULE STRUCTURE

# 2.1 Counter Drawing

### 2.1.1 LCM Mechanical Diagram

\* See Appendix

### 2.1.2 Block Diagram





# 2.2 Interface Pin Description

# **TFT LCM Interface**

Pin#	Name	DESCRIPTION
1	GND	Power Ground.
2	VDD	Power for Digital Circuit.
3	VDD	Power for Digital Circuit.
4	VCC	Power For LED backlight.
5	VCC	Power For LED backlight.
6	PWM	Shutdown & Dimming control input for backlight. Do not allow this pin to float. "Hi" =100%, "Low" = 0%.
7	GND	Power Ground.
8	R0	Red Data.
9	R1	Red Data.
10	R2	Red Data.
11	R3	Red Data.
12	GND	Power Ground.
13	R4	Red Data.
14	R5	Red Data.
15	R6	Red Data.
16	R7	Red Data.
17	GND	Power Ground.
18	G0	Green Data.
19	G1	Green Data.
20	G2	Green Data.
21	G3	Green Data.
22	GND	Power Ground.
23	G4	Green Data.
24	G5	Green Data.
25	G6	Green Data.
26	G7	Green Data.
27	GND	Power Ground.
28	В0	Blue Data.
29	B1	Blue Data.



Pin#	Name	DESCRIPTION
30	B2	Blue Data.
31	В3	Blue Data.
32	GND	Power Ground.
33	B4	Blue Data.
34	B5	Blue Data.
35	B6	Blue Data.
36	B7	Blue Data.
37	GND	Power Ground.
38	HS	Line synchronization signal. Horizontal Sync Input.
39	VS	Frame synchronization signal. Vertical Sync Input.
40	GND	Power Ground.
41	DE	Display enable pin from controller. Data Input Enable.
42	GND	Power Ground.
43	DCLK	Sample clock. Data shall be latched at the falling edge of DCLK.
44	GND	Power Ground.
45	CS(NC) / ID1	No Function./ ID[4:1]These pins select LCM type.
46	SDIN(NC) / ID2	No Function./ ID[4:1]These pins select LCM type.
47	SCK(NC) / ID3	No Function ./ ID[4:1]These pins select LCM type.
48	DISPLAY CONTROL / ID4	Display Enable(Hi Active)./ ID[4:1]These pins select LCM type.
49	/RESET	Global Reset(Low Active).
50	GND	Power Ground.

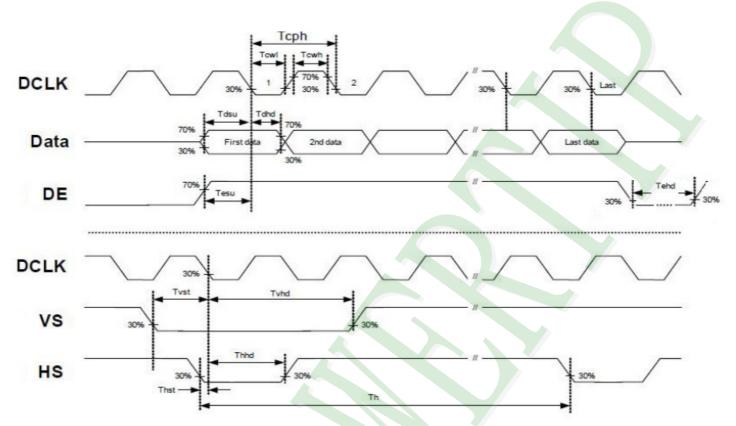
# 4-Wire Resistive Touch Screen (RTP) Interface

Pin No.	Symbol	Function
1	XR	TP: X right
2	YD	TP: Y bottom
3	XL	TP: X left
4	YU	TP: Y top



# 2.3 Timing Characteristics

# 2.3.1 Signal AC Characteristics



и	Ok al		Values		l lada	Downsels
Item	Symbol	Min	Тур	Max	Unit	Remark
HS setup time	Thst	8	-	-	ns	
HS hold time	Thhd	8	-	-	ns	
VS setup time	Tvst	8	-	-	ns	
VS hold time	Tvhd	8	-	-	ns	
Data setup time	Tdsu	8	-	-	ns	
Data hole time	Tdhd	8	-	-	ns	
DE setup time	Tesu	8	-	-	ns	
DE hold time	Tehd	8	-	-	ns	
DVDD Power On Slew rate	TPOR	-	-	20	ms	From 0 to 90% DVDD
RESET pulse width	TRst	1	-	-	ms	90 % D V D D
DCLK cycle time	Tcph	20	30	-	ns	
Low Level Width	Tcwl	8	-	-	ns	
High Level Width	Tcwh	8	-	-	ns	
DCLK pulse duty	Duty	40	50	60	%	Tcwh / Tcph



### 2.3.2 Input Timing Setting

Item	Symbol	Values			Unit	Remark
		Min.	Тур.	Max.		
Horizontal Display Area	Thd		800		DCLK	
DCLK Frequency	Fclk	26.4	33.3	46.8	MHz	
One Horizontal Line	Th	862	1056	1200	DCLK	
HS pulse width	Thpw	1		40	DCLK	
HS Blanking	Thb	46	46	46	DCLK	
HS Front Porch	Thfp	16	210	354	DCLK	

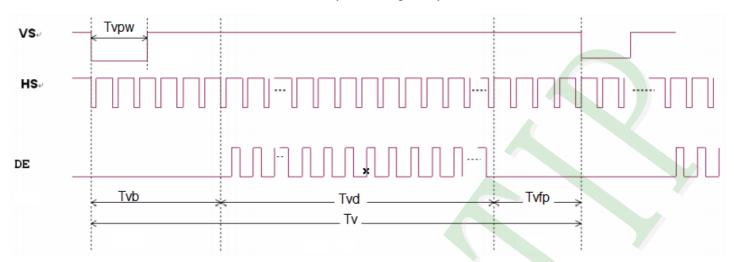
Item	Symbol	Values		Unit	Remark	
		Min.	Тур.	Max.		
Vertical Display Area	Tvd		480		TH	
VS period time	Τv	510	525	650	TH	
VS pulse width	Tvpw	1		20	TH	
VS Blanking	Tvb	23	23	23	TH	
VS Front Porch	Tvfp	7	22	147	TH	

# Horizontal input timing diagram





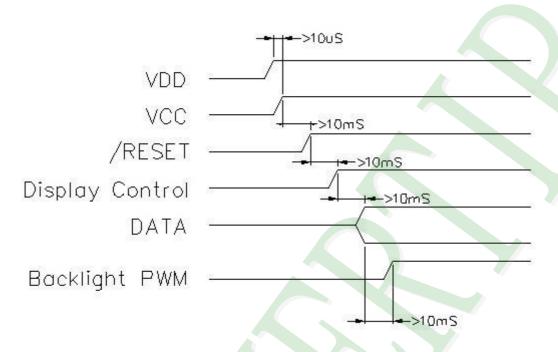
# Vertical input timing diagram



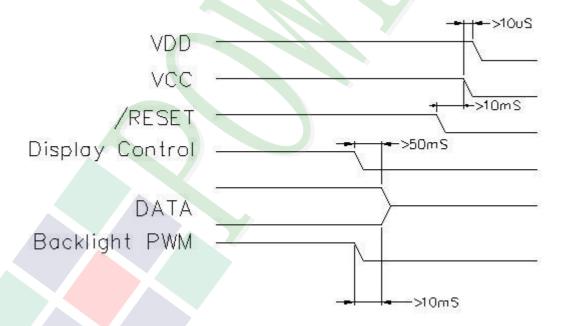


# 2.3.3 Power Sequence

#### **POWER ON**



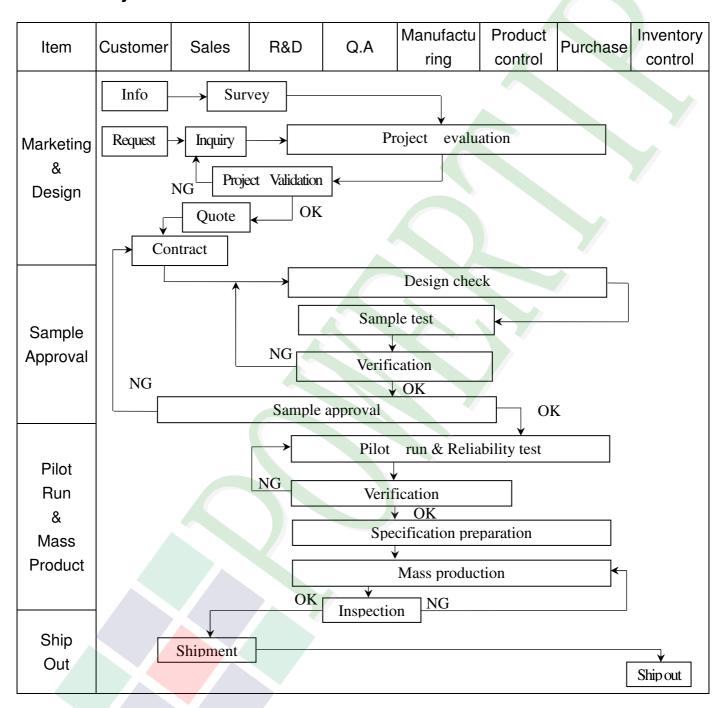
#### **POWER OFF**



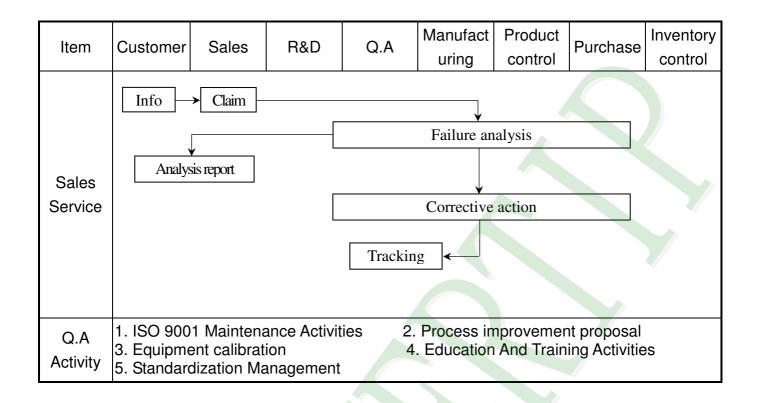


### 3. QUALITY ASSURANCE SYSTEM

### 3.1 Quality Assurance Flow Chart



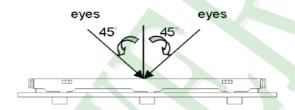




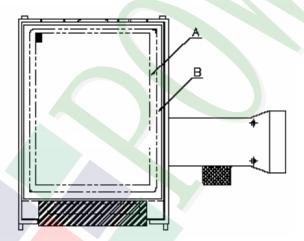


### 3.2. Inspection Specification

- Scope: The document shall be applied to TFT-LCD Module for 3,  $5'' \sim 10''$  (Ver.B01).
- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment: Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect AQL: 1.5
- **♦**OUT Going Defect Level: Sampling.
- ◆Standard of the product appearance test:
  - a. Manner of appearance test:
  - (1). The test best be under 20W×2 fluorescent light, and distance of view must be at 30 cm.
  - (2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5" ~10":

(Ver.B01)

NO	Item	Criterion	Level			
		1. 1The part number is inconsistent with work order of production.				
01	Product condition	1. 2 Mixed product types.	Major			
		1, 3 Assembled in inverse direction.				
02	Quantity	2. 1The quantity is inconsistent with work order of production.	Major			
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major			
		4. 1 Missing line character and icon.	Major			
04	Electrical Testing	4. 2 No function or no display.				
		4. 3 Display malfunction.				
		4. 4 LCD viewing angle defect.	Major			
		4. 5 Current consumption exceeds product specifications.	Major			
		Item Acceptance (Q'ty)				
	Dot defect	Bright Dot ≤ 4				
	Dot defect	$\mathbf{Dot}$ $\mathbf{Dark}\mathbf{Dot}$ $\leq 5$				
	(Bright dot \	Defect Joint Dot ≤ 3				
05	Dark dot)	Total ≤ 7	Minor			
	On -display	5. 1 Inspection pattern: full white, full black, Red, Green and				
	blue screens.  5. 2 It is defined as dot defect if defect area >1/2 dot.					
		5. 3 The distance between two dot defect ≥5 mm.				



# ◆Specification For TFT-LCD Module 3. 5″ ~10″:

(Ver.B01)

NO	Item	Criterion				
		6. 1 Round type ( Non-display or display) :				
		Dimension (diameter : Φ)  Acceptance (Q'ty)  A area  B area				
	Black or white dot \ scratch \	$\Phi \le 0.25$ Ignore				
	contamination	$0.25 < \Phi \leq 0.50$				
	Round type	$\Phi > 0.50$ Ignore				
	$X \longrightarrow Y$	Total 5				
06	$\Phi = (x+y)/2$	6. 2 Line type( Non-display or display):	Minor			
	, ,,	Length (L) Width (W) Acceptance (Q'ty)				
	Line type	A area B area				
	✓ † W	$W \le 0.03 \qquad \text{Ignore}$				
	→ı <sub>L</sub>	$L \le 10.0 \qquad 0.03 < W \le 0.05 \qquad 4$				
		$L \le 5.0 \qquad 0.05 < W \le 0.10 \qquad 2 \qquad Ignore$ $W > 0.10 \qquad As round$				
		$ \qquad \qquad W > 0.10 \qquad \begin{array}{c} As \ round \\ type \end{array}$				
		Total 5				
		Dimension (diameten: 4) Acceptance (Q'ty)				
		Dimension (diameter : Φ)  Acceptance (Q ty)  A area  B area				
		$\Phi \leq 0.25$ Ignore				
07	Polarizer Bubble	$0.25  <  \Phi \leqq 0.50 \qquad \qquad 4$	Minor			
	Duoble	$0.50 < \Phi \leq 0.80$ 1 Ignore				
		$\Phi > 0.80$				
		Total 5				



# **Specification For TFT-LCD Module** $3.5'' \sim 10''$ : (Ver.B01) NO Item Criterion Level Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 8.1 General glass chip: 8. 1. 1 Chip on panel surface and crack between panels: 08 The crack of glass Minor [NG] [OK] Seal width $\mathbf{Y}$ $\mathbf{X}$ Z Crack can't enter $\leq 1/2 t$ ≦ a viewing area

≦ a

Crack can't exceed the

half of SP width.

 $1/2 t < Z \leq 2 t$ 



# ◆Specification For TFT-LCD Module 3, 5" ~10": (Ver.B01) NO Item Criterion Level Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 8.1.2 Corner crack: X Z Y Crack can't enter $\leq 1/5$ a $Z \leq 1/2 t$ viewing area Crack can't exceed the $\leq 1/5$ a $1/2 t < Z \leq 2 t$ half of SP width. 08 The crack of glass Minor 8.2 Protrusion over terminal: 8. 2. 1 Chip on electrode pad: $\mathbf{X}$ Y Z $\leq 1/2 \text{ W}$ $\leq t$ Front ≦ a Back $\leq a$ W $\leq 1/2 t$ $\leq$



# ◆Specification For TFT-LCD Module 3, 5" ~10": (Ver.B01) NO Level Item Criterion Symbols: X: The length of crack Y: The width of crack. Z: The thickness of crack W: terminal length t: The thickness of glass a: LCD side length 8.2.2 Non-conductive portion: X Z Y $\leq 1/3$ a The crack of $\leq W$ $\leq t$ 80 Minor glass ⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications. 8. 2. 3 Glass remain: Pitch $\mathbf{Z}$ X Y

 $\leq a$ 

 $\leq 1/3 \text{ W}$ 

≦t



# 4. RELIABILITY TEST

# 4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CO	ONDITION			
1	High Temperature Storage Test	Keep in +80 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.				
2	Low Temperature Storage Test	Keep in −30 ±2°C 96 hrs Surrounding temperature, then storage at normal condition 4hrs.				
3	High Temperature / High Humidity Storage Test	Keep in +60 °C / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)				
4	Temperature Cycling Storage Test	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$				
5	ESD Test	Air Discharge:  Apply 2 KV with 5 times  Discharge for each polarity +/-  1. Temperature ambiance: 15°C ~35°C  2. Humidity relative: 30% ~60%  3. Energy Storage Capacitance(Cs+Cd): 150pF±10%  4. Discharge Resistance(Rd): 330Ω±10%  5. Discharge, mode of operation:  Single Discharge (time between successive discharges at least 1 sec (Tolerance if the output voltage indication: ±5%)				
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequency (1 min/sweep)</li> <li>The amplitude of vibration :1.5 mm</li> <li>Each direction (X \ Y \ Z) duration for 2 Hrs</li> </ol>				
7	Drop Test (Packaged)	Packing Weight (Kg)  0 ~ 45. 4  45. 4 ~ 90. 8  90. 8 ~ 454  Over 454  Drop Direction: %1 corner / 3 edg	122 76 61 46			



### 5. PRECAUTION RELATING PRODUCT HANDLING

#### **5.1 SAFETY**

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### **5.2 HANDLING**

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

#### **5.3 STORAGE**

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}$ C  $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

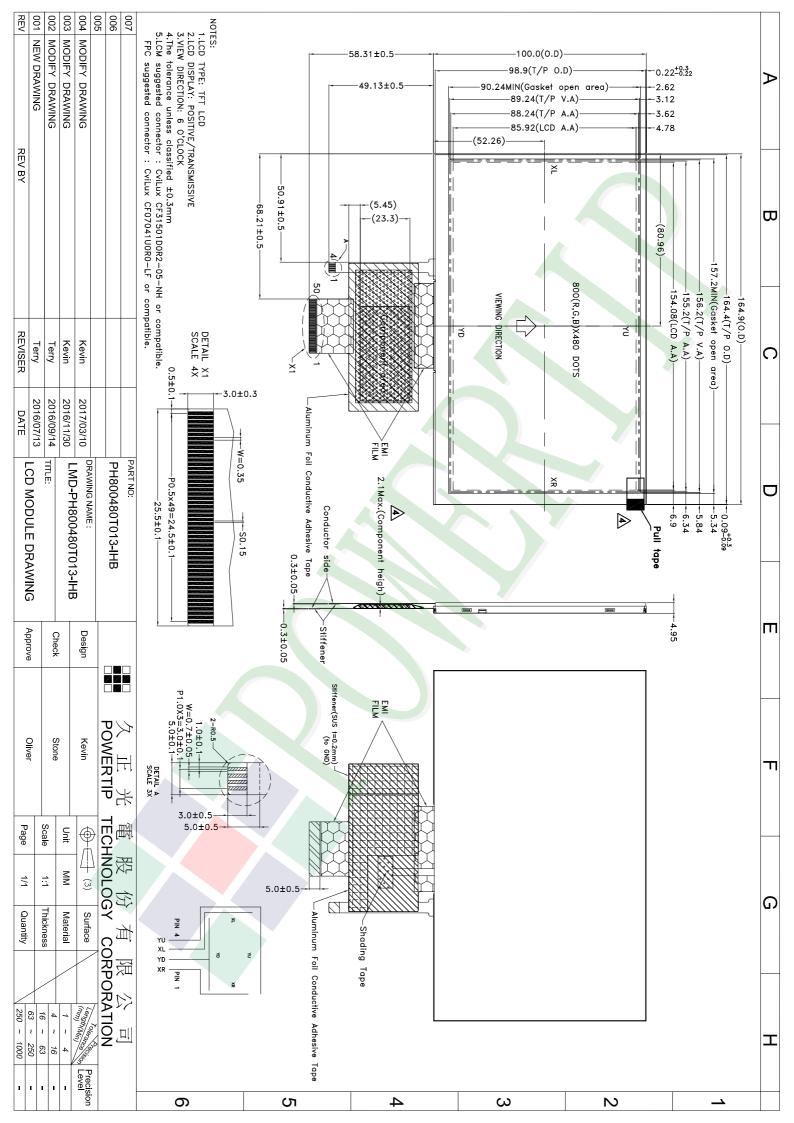
#### **5.4 TERMS OF WARRANTY**

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Ver	:.001	I CM =	出出校書	Approve	Check	Contact
	cuments NO. PKG-PH800480T013	I CM Dealers:	L裝規格書 ng Specification	s Oliver	Stone	Kevin
	difficition (C.)					
1.乍	型裝材料規格表 (Packaging Ma	nterial): (per carton)				
No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH800480T013-IHB	164.9 X 100.0 X 4.95	0.168	60	10.08
2	靜電袋(1)Antistatic Bag	BAG240170ARABA	240 X 170	0.0048	60	0.288
3	上蓋(2)EPE	FOAM00000078 FOAM000000079	310 X 250 X 90 310 X 250 X 100	0.1	4	0.4
<u>4</u> 5	下座(3)EPE 海綿墊(4)Foam Rubber Cushion	OTFOAM00006ABA	290 X 240 X 10	0.17	4	0.68
6	外紙箱(5)Carton	BX52732536CCBA	527 X 325 X 360	1.092	1	1.092
7	7 THOUSE CONTROL	511027020000511	027 11020 11000	1.072	1	1.072
8						
9						
2.—	- 整箱總重量 (Total LCD Weight	in carton): 12.56 Kg±	10%			
	L箱數量規格表 (Packaging Specifi )Total LCD quantity in carton : qua		x no of boxes	4	= 60	
	, rotal Beb qualities in outlon : qual		He er cenes	7	- 00	
	(2)上蓋一EPE  (1)靜電袋+LCM— Antistatic Bag+LC		項 (REMARK)		— (5)外紅 Car	
	包裝數量不足時需以EPE(舒					
	也表数重个定时而以正式(d) 垫)填補空槽					
	EPE:OTFOAMEP0003BA自表	就				
	166.5X109.0X10mm)					
,	100.2/1107.0/110111111					





# ALL TECHNOLOGIES. ALL COMPETENCIES. ONE SPECIALIST.



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